

# **TDA10026HN**

# Single cable demodulator with Out-Of Band receiver

Rev. 1 — 6 October 2011

**Product short data sheet** 

## 1. General description

The TDA10026HN is a Single Cable Downstream Processor.

The Cable Downstream Processor (CDP) implements the physical interfaces and protocols required to provide the highest quality services of an in-band DOCSIS, EuroDOCSIS, DVB and OpenCable Set-Top Box (STB). The downstream signals are digitized by 12-bit ADC and passed to the Demod and Forward Error Correction (FEC) blocks, which do all the cable physical layer processing. This processing includes demodulating and Annex A (Europe), Annex B (US) or Annex C (Japan) FEC for the in-band data.

The Out-Of Band (OOB) receiver consists of a QPSK demodulator with FEC, compliant to SCTE55-1 and SCTE55-2 standards, with either internal MAC or POD support. Data are digitized by a 10-bit ADC.

#### 2. Features and benefits

- QPSK, 16 QAM, 32 QAM, 64 QAM, 128 QAM and 256 QAM Demodulator
- ITU-T J83 Annex A, B and C FEC
- Transport Stream Multiplex Frame (TSMF) module for Annex C compliance
- Time interleaved parallel mode or serial mode for Transport Stream (TS) interface
- On chip PLL for crystal frequency multiplication (16 MHz external)
- Reuse of the tuner clock, saving one crystal
- Embedded 12-bit ADC
- 3.3 V and 1.2 V power supplies
- Low power < 160 mW for dual stream operation
- Small size package
- Low cost Bill of Material
- OOB:
  - QPSK demodulator
  - ◆ SCTE55-1 and SCTE55-2 FEC
  - Embedded 10-bit ADC



## Single cable demodulator with Out-Of Band receiver

## 3. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Р	power dissipation	Standby mode:	-	10 <u>[1]</u>	30[2]	mW
		all 3 ADC in Power-down mode and all clocks disabled				
		operation mode:				
		1.2 V supply voltage; 1 DVB-C demodulation (256 QAM 6.9 Msps) and 1 OOB SCTE55-1	-	130 <sup>[1]</sup>	190[2]	mW
		3.3 V supply voltage; 1 DVB-C demodulation (256 QAM 6.9 Msps) and 1 OOB SCTE55-1	-	30 <u>[1]</u>	50[2]	mW
P <sub>tot</sub>	total power dissipation	1 DVB-C demodulation (256 QAM 6.9 Msps) and 1 OOB SCTE55-1	-	160 <sup>[1]</sup>	240[2]	mW
V <sub>DD(1V2)</sub>	supply voltage (1.2 V)		1.15	1.2	1.3	V
$V_{DD(3V3)}$	supply voltage (3.3 V)		3.0	3.3	3.6	V
V <sub>IH</sub>	HIGH-level input voltage	e V <sub>DD(3V3)</sub> related input levels	2.0	-	V <sub>DD(3V3)</sub> + 0.5	V
$V_{IL}$	LOW-level input voltage		-0.5	-	+0.8	V

<sup>[1]</sup>  $T_{amb} = 25 \, ^{\circ}C$ ,  $V_{DD(1V2)}$  and  $V_{DD(3V3)}$  typical.

# 4. Ordering information

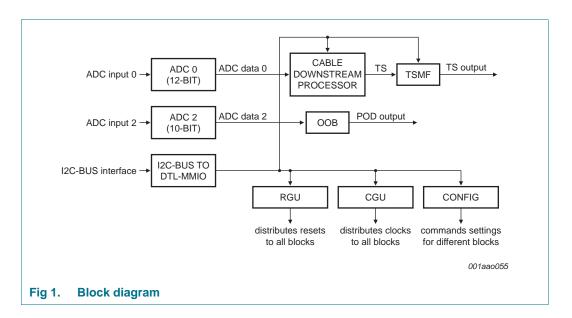
Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
TDA10026HN/ C1	HVQFN64	plastic thermal enhanced very thin quad flat package; no leads; 64 terminals; body; $9 \times 9 \times 0.85$ mm	SOT804-4	

<sup>[2]</sup>  $T_j = 120~^{\circ}C,~V_{DD(1V2)}$  and  $V_{DD(3V3)}$  maximum.

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# 5. Block diagram



# 6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$T_{stg}$	storage temperature		-40	+150	°C
Tj	junction temperature		-	120	°C
$V_{ESD}$	electrostatic discharge voltage	EIA/JESD22-A114 (HBM)	2	-	kV
		EIA/JESD22-C101-C (FCDM)	<u>[1]</u> 0.5	-	kV

<sup>[1]</sup> It withstands class IV of JEDEC standard.

## 7. Abbreviations

Table 4. Abbreviations

Aaranym	Description
Acronym	Description
ADC	Analog to Digital Converter
CDP	Cable Downstream Processor
CGU	Clock Generation Unit
DOCSIS	Data Over Cable Service Interface Specifications
DVB-C	Digital Video Broadcasting - Cable
DVD	Digital Versatile Disc
FCDM	Field-Induced Charged-Device Model
FEC	Forward Error Correction
HBM	Human Body Model
MAC	Media Access Control

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 Table 4.
 Abbreviations ...continued

Acronym	Description
MUX	MUltipleXer
ООВ	Out-Of Band
PLL	Phase-Locked Loop
POD	Point Of Deployement
QAM	Quadrature Amplitude Modulation
QPSK	Quadrature Phase Shift Keying
RGU	Reset Generation Unit
STB	Set-Top Box
TS	Transport Stream
TSMF	Transport Stream Multiplex Frame
US	United States

# 8. Revision history

#### Table 5. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
TDA10026HN_SDS v.1	20111006	Product short data sheet	-	-

#### Single cable demodulator with Out-Of Band receiver

## 9. Legal information

#### 9.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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